**3GPP TSG-RAN WG2 Meeting #1010-e *draft*R2-2005829**

**Online, 1st  - 12th June 2020**

**Agenda Item: 7.1.5**

**Source: Huawei, HiSilicon**

**Title: draft Report from [Offline-409] RAN1 feature list and UE capabilities issues for eMTC**

**Document for: Discussion and Decision**

# Introduction

This document discusses remaining eMTC Capabilities opens issues, based on [1]

# Discussion

In this section we collect company opinions on the proposals made in [1], except for proposal 10-2 which is covered in Offline-201.

## RAN2 open issues:

**Proposal 1:** Move the four PUR capabilities to general capabilities in the eMTC RRC correction CR.

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | Yes but | The capabilities should be grouped in PUR-Paramters because PUR capabilities affect multiple layers e.g. RRC, MAC, Phy. This should be handled in running CR, see eMTC RRC CR. |

**Proposal 2:** Change the group Wake Up Signal capabilities names in the eMTC correction CR so the names align with NB-IoT and Rel-15 capabilities names.

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | Yes | Generally eMTC capabilities have FDD/TDD differentiation in the name but for WUS R15 this general rule was not followed. To avoid confusion to the reader, ok to follow R15 scheme for FDD/TDD differentiation for group WUS. |

**Proposal 3:** Align the naming of ce mode A/B specific capabilities to align to those in Rel-15 (e.g. similar to ce-PDSCH-FlexibleStartPRB-CE-ModeA-r15)

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | Not really | For example, there is no need to repeat “ce” twice in the same field name. Therefore, prefer to stick to what is already in the eMTC RRC CR, i.e., ce-ModeA-PDSCH-MultiTB-r16. It is more compact. |

## RAN1 Feature List Impact:

### PUR

**Proposal 4-1:** For eMTC, introduce a new general capability *pur-PUSCH-NB-MaxTBS-r16*, conditional to support of (*pur-CP-EPC-r16* and/or *pur-CP-5GC-r16* and/or *pur-UP-EPC-r16* and/or *pur-CP-EPC-r16)* and *ce-PUSCH-NB-MaxTBS.*

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | No | The pre-requisite should be on ce-PUSCH-NB-MaxTBS-r15 and at least one of the pur-CP-EPC-r16, pur-CP-5GC-r16, pur-UP-EPC-r16 and pur-UP-5GC-r16 for full PRB CE mode A. See proposal 4-2.  |

**Proposal 4-2:** For eMTC, introduce a new general capability *pur-CE-ModeB-r16*, conditional to support of *pur-CP-EPC-r16* and/or *pur-CP-5GC-r16* and/or *pur-UP-EPC-r16* and/or *pur-CP-EPC-r16.*

**Company views (to be completed during the meeting)**

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| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | maybe | We prefer to have separate capability (i.e., pur-CP-EPC-r16, pur-CP-5GC-r16, pur-UP-EPC-r16, pur-UP-5GC-r16) for both CE mode A and CE mode B for full PRB.Otherwise, for example following option would not be possible* Support of pur-CP-EPC-r16 in CE mode A/B but pur-UP-EPC-r16 only in CE mode A.

It can be handled in running CR. |

**Proposal 4-3:** For eMTC, introduce a new physical layer capability *pur-Sub-PRB-CE-ModeA-r16*, conditional to support of (*pur-CP-EPC-r16* and/or *pur-CP-5GC-r16* and/or *pur-UP-EPC-r16* and/or *pur-CP-EPC-r16)* and *ce-PUSCH-SubPRB-Allocation-r15.*

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm |  | It is as per RAN1 UE feature list. As per RAN1 UE feature list, UE capabilities are captured in eMTC RRC running CR. Similarly, the UE capabilities and dependency can be captured in 36.306 running CR. Therefore, it can be handled in the running CR. |

**Proposal 4-4:** For eMTC, introduce a new physical layer capability *pur-Sub-PRB-CE-ModeB-r16*, conditional to support of (*pur-CP-EPC-r16* and/or *pur-CP-5GC-r16* and/or *pur-UP-EPC-r16* and/or *pur-CP-EPC-r16)* and *pur-CE-ModeB-r16* and *ce-PUSCH-SubPRB-Allocation-r15.*

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm |  | The pre-requisite should be the support of at least one of the pur-CP-EPC-r16, pur-CP-5GC-r16, pur-UP-EPC-r16 and pur-UP-5GC-r16 for CE mode B and ce-PUSCH-SubPRB-Allocation-r15 |

**Proposal 4-5:** For eMTC, introduce a new physical layer capability *pur-FrequencyHopping-r16*, conditional to support of *pur-CP-EPC-r16* and/or *pur-CP-5GC-r16* and/or *pur-UP-EPC-r16* and/or *pur-CP-EPC-r16.*

**Company views (to be completed during the meeting)**

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| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | yes | Pre-requisite should be support of at least one of the pur-CP-EPC-r16, pur-CP-5GC-r16, pur-UP-EPC-r16, pur-UP-5GC-r16 for full PRB CE mode A (not applicable to CE mode B). |

### MultiTB scheduling

**Proposal 5-1:** For eMTC, introduce a new physical layer capability *ce-MultiTB-Interleaving-r16*, conditional to support of *ce-ModeA-PUSCH-MultiTB-r16* and/or *ce-ModeB-PUSCH-MultiTB-r16* and/or *ce-ModeA-PDSCH-MultiTB-r16* and/or *ce-ModeB-PDSCH-MultiTB-r16.*

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | yes | It is as per RAN1 UE feature list. As per RAN1 UE feature list, UE capabilities are captured in eMTC RRC running CR. Similarly, the UE capabilities and their dependency can be captured in 36.306 running CR. Therefore, there is no need to discuss and agree each UE capability. |

**Proposal 5-2:** For eMTC, introduce a new physical layer capability *ce-MultiTB-HARQ-Bundling-r16*, conditional to support of *ce-ModeA-PDSCH-MultiTB-r16.*

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | yes | To be handled in running CR. |

**Proposal 5-3:** For eMTC, introduce a new physical layer capability *ce-MultiTB-Sub-PRB-r16*, conditional to support of (*ce-ModeA-PUSCH-MultiTB-r16* and/or *ce-ModeB-PUSCH-MultiTB-r16)* and *ce-PUSCH-SubPRB-Allocation-r15.*

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | yes | To be handled in running CR. |

**Proposal 5-4:** For eMTC, introduce a new physical layer capability *ce-MultiTB-EarlyTermination-r16*, conditional to support of *ce-ModeA-PUSCH-MultiTB-r16* and/or *ce-ModeB-PUSCH-MultiTB-r16.*

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | yes | To be handled in running CR. |

**Proposal 5-5:** For eMTC, introduce a new physical layer capability *ce-MultiTB-64QAM-r16*, conditional to support of *ce-ModeA-PDSCH-MultiTB-r16* and *ce-PDSCH-64QAM-r15.*

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | yes | To be handled in running CR. |

**Proposal 5-6:** For eMTC, introduce a new physical layer capability *ce-MultiTB-FrequencyHopping-r16*, conditional to support of *ce-ModeA-PUSCH-MultiTB-r16* and/or *ce-ModeB-PUSCH-MultiTB-r16* and/or *ce-ModeA-PDSCH-MultiTB-r16* and/or *ce-ModeB-PDSCH-MultiTB-r16.*

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | yes | To be handled in running CR. |

**Proposal 5-7:** For eMTC, introduce a new capability without radio access capability signaling for Multi-TB SC-MTCH in CE-modeB.

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm |  | This is optional capability without signalling so it can be captured together for CE mode A and B. |

### Resource reservation for NR

**Proposal 6-1:** Rename the four already defined capabilities to *ce-SubframeResourceResvUL-CE-ModeA-r16, ce-SubframeResourceResvDL-CE-ModeA-r16, ce-SubframeResourceResvDL-CE-ModeA-r16, ce-SubframeResourceResvDL-CE-ModeB-r16*

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | no | There is no need to repeat “ce” as our reponse to Proposal 3. Prefer the following naming:*ce-ModeA-SubframeResourceResvUL-r16, ce-ModeA-SubframeResourceResvDL-r16, ce-ModeB-SubframeResourceResvDL-r16, ce-ModeB-SubframeResourceResvDL-r16.*This can be handled in running CR. |

**Proposal 6-2:** Introduce four new physical layer capabilities *ce-SlotSymbolResourceResvUL-CE-ModeA-r16, ce-SlotSymbolResourceResvUL-CE-ModeB-r16, ce-SlotSymbolResourceResvDL-CE-ModeA-r16, ce-SlotSymbolResourceResvDL-CE-ModeB-r16* to support of slot/symbol level granularity.

**Company views (to be completed during the meeting)**

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| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | yes | There is no need to repeat “ce” in the naming, see proposal 6-1.  |

### MPDCCH Performance Improvement

**Proposal 7-1:** Rename existing capability to *ce-CRS-ChannelEstMPDCCH-CE-ModeA-r16*

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | no | As per response to Proposal 3, prefer the following: *ce-ModeA-CRS-ChannelEstMPDCCH-r16.* It can be handled in running CR. |

**Proposal 7-2:** Introduce a new physical layer capability *ce-CRS-ChannelEstMPDCCH-CE-ModeB-r16*

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm |  | To be handled in running CR. |

**Proposal 7-3:** Introduce a new physical layer capability *ce-CRS-ChannelEstMPDCCH-CSI-CE-ModeB-r16* conditional to support of *ce-CRS-ChannelEstMPDCCH-CE-ModeA-r16*

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm |  | To be handled in running CR. |

**Proposal 7-4:** Introduce a new physical layer capability *ce-CRS-ChannelEstMPDCCH-reciprocity-TDD-r16* conditional to support of *ce-CRS-ChannelEstMPDCCH-CE-ModeA-r16* and/or *ce-CRS-ChannelEstMPDCCH-CE-ModeB-r16*

**Company views (to be completed during the meeting)**

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| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | yes | To be handled in running CR. |

### CSI-RS Feedback

**Proposal 8-1:** Introduce a new physical layer capability *ce-ModeA-CodebookRestriction-CSI-RS-Feedback-r16* conditional to support of *ce-ModeA-CSI-RS-Feedback-r16*

**Company views (to be completed during the meeting)**

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| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | yes | To be handled in running CR. |

### LTE Control Channel use

**Proposal 9-1:** Rename existing capability to *ce-MPDCCH-RxInLTE-ControlRegion-CE-ModeA-r16*

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | no | As per our response to Proposal 3, prefer the following: *ce-ModeA-MPDCCH-RxInLTE-ControlRegion-r16* |

**Proposal 9-2:** Introduce 3 new capabilities *ce-MPDCCH-RxInLTE-ControlRegion-CE-ModeB-r16, ce-MPDSCH-RxInLTE-ControlRegion-CE-ModeA-r16, ce-MPDSCH-RxInLTE-ControlRegion-CE-ModeB-r16*

**Company views (to be completed during the meeting)**

|  |  |  |
| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | No | See proposal 9-1 for naming. The new UE capabilities should be handled in running CR. |

### Other

**Proposal 10-1:** Introduce UE-EUTRA-CapabilityAddXDD-Mode container for all of the newly introduced Release-16 physical layer capabilities.

**Company views (to be completed during the meeting)**

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| --- | --- | --- |
| **Company** | **Do you agree (yes/no)** | **Comments (including whether there is anything missing from the list)** |
| Qualcomm | yes | Yes for the capabilities that need FDD/TDD differentiation. |

# 3 Conclusion

In this document, we have discussed miscellaneous WI open issues and made the following proposals:

[To be completed after offline]

# 4 References

1. [R2-2005085](https://www.3gpp.org/ftp/tsg_ran/WG2_RL2/TSGR2_110-e/Docs/R2-2005085.zip) “RAN1 feature list and UE capabilities issues for eMTC”, Huawei, HiSilicon